

# FAN7390 High-Current, High & Low-Side, Gate-Drive IC

### Features

- Floating Channels for Bootstrap Operation to +600V
- Typically 4.5A/4.5A Sourcing/Sinking Current Driving Capability
- Common-Mode dv/dt Noise Canceling Circuit
- Built-in Under-Voltage Lockout for Both Channels
- Matched Propagation Delay for Both Channels
- Logic (V<sub>SS</sub>) and Power (COM) Ground +/- 7V Offset
- 3.3V and 5V Input Logic Compatible
- Output In-phase with Input

### Applications

- PDP Sustain Driver
- HID Lamp Ballast
- SMPS
- Motor Driver

### Description

The FAN7390 is a monolithic high- and low-side gatedrive IC, which can drive high speed MOSFETs and IGBTs that operate up to +600V. It has a buffered output stage with all NMOS transistors designed for high pulse current driving capability and minimum cross-conduction.

Fairchild's high-voltage process and common-mode noise canceling techniques provide stable operation of the high-side driver under high dv/dt noise circumstances. An advanced level shift circuit offers high-side gate driver operation up to  $V_{S}$ =-9.8V (typical) for  $V_{BS}$ =15V.

The UVLO circuit prevents malfunction when  $V_{DD}$  and  $V_{BS}$  are lower than the specified threshold voltage.

The high current and low output voltage drop feature make this device suitable for the PDP sustain pulse driver, motor driver, switching power supply, and high-power DC-DC converter applications.



# **Ordering Information**

Part Number	Package	Operating Temperature Range	Eco Status	Packing Method
FAN7390N	8-DIP			Tube
FAN7390M	8-SOP	-40°C ~ 125°C		Tube
FAN7390MX	0-30P		RoHS	Tape & Reel
FAN7390M1	14-SOP			Tube
FAN7390M1X	14-SOP			Tape & Reel

V For Fairchild's definition of "green" Eco Status, please visit: <u>http://www.fairchildsemi.com/company/green/rohs\_green.html</u>.



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Figure 5. Pin Assignments (Top View)

# **Pin Definitions**

8-Pin	14-Pin	Name	Description	
1	1	HIN	Logic Input for High-Side Gate Driver Output	
2	2	LIN	Logic Input for Low-Side Gate Driver Output	
	3	V <sub>SS</sub>	Logic Ground (FAN7390M1 only)	
3	5	COM	Low-Side Driver Return	
4	6	LO	Low-Side Driver Output	
5	7	V <sub>DD</sub>	Low-Side and Logic Part Supply Voltage	
6	11	V <sub>S</sub>	High-Voltage Floating Supply Return	
7	12	HO	High-Side Driver Output	
8	13	V <sub>B</sub>	High-Side Floating Supply	
	4, 8, 9, 10, 14	NC	No Connect	

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.  $T_A=25^{\circ}C$ , unless otherwise specified.

Symbol	Characteristics	Min.	Max.	Unit
V <sub>S</sub>	High-Side Floating Supply Offset Voltage	V <sub>B</sub> -25	V <sub>B</sub> +0.3	V
VB	High-Side Floating Supply Voltage	-0.3	625.0	V
V <sub>HO</sub>	High-Side Floating Output Voltage HO	V <sub>S</sub> -0.3	V <sub>B</sub> +0.3	V
V <sub>DD</sub>	Low-Side and Logic Fixed Supply Voltage	-0.3	25.0	V
V <sub>LO</sub>	Low-Side Output Voltage LO	-0.3	V <sub>DD</sub> +0.3	V
V <sub>IN</sub>	Logic Input Voltage (HIN and LIN)	V <sub>SS</sub> -0.3	V <sub>DD</sub> +0.3	V
V <sub>SS</sub>	Logic Ground (FAN7390M1 only)	V <sub>DD</sub> -25	V <sub>DD</sub> +0.3	V
dV <sub>S</sub> /dt	Allowable Offset Voltage Slew Rate		50	V/ns
		8-DIP	1.25	
PD	Power Dissipation <sup>(1)(2)(3)</sup>	8-SOP	0.625	W
		14-SOP	1.0	
	/	8-DIP	100	
$\theta_{JA}$	Thermal Resistance, Junction-to-Ambient	8-SOP	200	°C/W
		14-SOP	110	
TJ	Junction Temperature		+150	°C
T <sub>STG</sub>	Storage Temperature		+150	°C

#### Notes:

- 1. Mounted on 76.2 x 114.3 x 1.6mm PCB (FR-4 glass epoxy material).
- 2. Refer to the following standards:

JESD51-2: Integral circuits thermal test method environmental conditions - natural convection

- JESD51-3: Low effective thermal conductivity test board for leaded surface mount packages
- 3. Do not exceed P<sub>D</sub> under any circumstances.

### **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Unit
VB	High-Side Floating Supply Voltage	V <sub>S</sub> +10	V <sub>S</sub> +20	V
VS	High-Side Floating Supply Offset Voltage	6-V <sub>DD</sub>	600	V
V <sub>HO</sub>	High-Side Output Voltage	V <sub>S</sub>	V <sub>B</sub>	V
V <sub>DD</sub>	Low-Side and Logic Supply Voltage	10	20	V
V <sub>LO</sub>	Low-Side Output Voltage	COM	V <sub>DD</sub>	V
V <sub>IN</sub>	Logic Input Voltage (HIN and LIN)	V <sub>SS</sub>	V <sub>DD</sub>	V
T <sub>A</sub>	Operating Ambient Temperature	-40	+125	°C

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# **Electrical Characteristics**

 $V_{BIAS}$  ( $V_{DD}$ ,  $V_{BS}$ )=15.0V,  $V_{S}$ = $V_{SS}$ =COM,  $T_{A}$ =25°C, unless otherwise specified. The  $V_{IL}$ ,  $V_{IH}$ , and  $I_{IN}$  parameters are referenced to  $V_{SS}$ /COM and are applicable to the respective input signals HIN and LIN. The  $V_{O}$  and  $I_{O}$  parameters are referenced to COM and  $V_{S}$  is applicable to the respective output signals HO and LO.

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
POWER \$	SUPPLY SECTION (V <sub>DD</sub> AND V <sub>BS</sub> )					
V <sub>DDUV+</sub> V <sub>BSUV+</sub>	V <sub>DD</sub> and V <sub>BS</sub> Supply Under-Voltage Positive-going Threshold		8.0	8.8	9.8	
V <sub>DDUV-</sub> V <sub>BSUV-</sub>	V <sub>DD</sub> and V <sub>BS</sub> Supply Under-Voltage Negative-going Threshold		7.4	8.3	9.0	V
V <sub>DDUVH</sub> V <sub>BSUVH</sub>	V <sub>DD</sub> and V <sub>BS</sub> Supply Under-Voltage Lockout Hysteresis Voltage			0.5		
I <sub>LK</sub>	Offset Supply Leakage Current	V <sub>B</sub> =V <sub>S</sub> =600V			50	
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> Supply Current	V <sub>IN</sub> =0V or 5V		45	80	μA
I <sub>QDD</sub>	Quiescent V <sub>DD</sub> Supply Current	V <sub>IN</sub> =0V or 5V		75	110	
I <sub>PBS</sub>	Operating V <sub>BS</sub> Supply Current	f <sub>IN</sub> =20kHz, rms value		530	640	μA
I <sub>PDD</sub>	Operating V <sub>DD</sub> Supply Current	f <sub>IN</sub> =20kHz, rms value		530	640	μΑ
LOGIC IN	IPUT SECTION (HIN, LIN)					
V <sub>IH</sub>	Logic "1" Input Voltage		2.5			V
VIL	Logic "0" Input Voltage				1.2	v
I <sub>IN+</sub>	Logic "1" Input Bias Current	V <sub>IN</sub> =5V		25	50	μA
I <sub>IN-</sub>	Logic "0" Input Bias Current	V <sub>IN</sub> =0V		1.0	2.0	μΛ
R <sub>IN</sub>	Input Pull-down Resistance		100	200		KΩ
GATE DR	RIVER OUTPUT SECTION (HO, LO)		_			
V <sub>OH</sub>	High-level Output Voltage, V <sub>BIAS</sub> -V <sub>O</sub>	No Load			1.0	V
V <sub>OL</sub>	Low-level Output Voltage, VO	No Load			35	mV
I <sub>O+</sub>	Output High, Short-circuit Pulsed Current <sup>(4)</sup>	$V_{O}$ =0V, $V_{IN}$ =5V with PW<10 $\mu$ s	3.5	4.5		А
I <sub>O-</sub>	Output Low, Short-circuit PulsedVO=15V, VIN=0V withCurrent <sup>(4)</sup> PW<10µs		3.5	4.5		A
Vs	Allowable Negative V <sub>S</sub> Pin Voltage for HIN Signal Propagation to HO		1	-9.8	-7.0	V
V <sub>SS</sub> - COM	V <sub>SS</sub> -COM/COM-V <sub>SS</sub> Voltage Educability		-7.0		7.0	V

### Note:

4. This parameter guaranteed by design.

# **Dynamic Electrical Characteristics**

V<sub>BIAS</sub> (V<sub>DD</sub>, V<sub>BS</sub>)=15.0V, V<sub>S</sub>=V<sub>SS</sub>=COM=0V, C<sub>L</sub>=1000pF and T<sub>A</sub>=25°C unless otherwise specified.

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
t <sub>on</sub>	Turn-on Propagation Delay	V <sub>S</sub> =0V		140	200	
t <sub>off</sub>	Turn-off Propagation Delay	V <sub>S</sub> =0V		140	200	
MT	Delay Matching, HS & LS Turn-on/off			0	50	ns
t <sub>r</sub>	Turn-on Rise Time			25	50	
t <sub>f</sub>	Turn-off Fall Time			20	45	



FAN7390 Rev. 1.0.2

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